



Product Change Notification

Change Notification #: 117005 - 00
Change Title: Intel® Server System R2224WFTZSR, PCN 117005 - 00, Product Design Update BIOS/BMC/ME/FRUSDR Firmware, System outer box J33994-001 stacking logo update
Date of Publication: June 17, 2019

Key Characteristics of the Change:

Product Design, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material *:	July 02, 2019
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Server System R2224WFTZSR:

1. Update BIOS revision to R02.01.0008
2. Update the Manageability Engine (ME) firmware revision to 04.01.04.251
3. Update the Baseboard Management Controller (BMC) firmware revision to 1.93.870cf4f0
4. Update the FRUSDR revision to 1.93

Intel is updating the system outer box stacking logo, original logo mean MAX 7-layers in total, however, only 6-layers as MAX can be supported by logistics racking limitation.

	Original outer box	New outer box
IPN	J33994-001	J33994-002
Description	System outer box with J33994-001 IPN and 6 layers stacking logo printing	Updated system outer box with J33994-002 IPN and 5 layers stacking logo printing
Photos		

Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
R2224WFTZSR	986051	K39998-001	H48104-871 H48104-881	K39998-002	H48104-872 H48104-882

PCN Revision History:

Date of Revision:

June 17, 2019

Revision Number:

00

Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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